

### 30V P-Channel Enhancement Mode MOSFET

Voltage -30 V Current

-48 A

#### **Features**

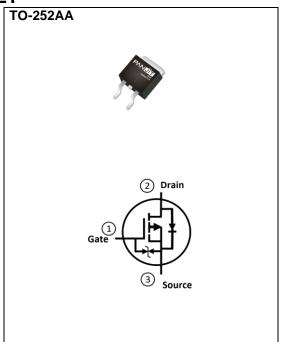
- R<sub>DS(ON)</sub>, V<sub>GS</sub>@-10V, I<sub>D</sub>@-20A<12.1mΩ
- RDS(ON), VGS@-4.5V, ID@-10A<20m $\Omega$
- 100% UIS tested
- Reliable and Rugged
- AEC-Q101 qualified
- Lead free in compliance with EU RoHS 2.0
- Green molding compound as per IEC 61249 standard

#### **Mechanical Data**

• Case: TO-252AA Package

• Terminals : Solderable per MIL-STD-750, Method 2026

• Approx. Weight: 0.3217 grams



# **Maximum Ratings and Thermal Characteristics** (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER		SYMBOL	LIMIT	UNITS	
Drain-Source Voltage		$V_{DS}$	-30	- V	
Gate-Source Voltage		$V_{GS}$	±25	V	
Continuous Drain Current(Note 3)	T <sub>C</sub> =25°C	l <sub>D</sub>	-48	A	
	T <sub>C</sub> =100°C		-34		
Pulsed Drain Current <sup>(Note 1)</sup>	T <sub>C</sub> =25°C	I <sub>DM</sub>	-143		
Power Dissipation	T <sub>C</sub> =25°C	Po	44	107	
	T <sub>C</sub> =100°C		22	W	
Continuous Drain Current(Note 4)	T <sub>A</sub> =25°C	I <sub>D</sub>	-12.4	^	
	T <sub>A</sub> =70°C		-10.4	A	
Power Dissipation	T <sub>A</sub> =25°C	Po	3	W	
	T <sub>A</sub> =70°C	Pυ	2.1		
Single Pulse Avalanche Energy <sup>(Note 5)</sup>		Eas	56	mJ	
Operating Junction and Storage Temperature Range		$T_{J}$ , $T_{STG}$	-55~175	°C	
Thermal Resistance <sup>(Note 4)</sup>	Junction to Case	$R_{ heta JC}$	3.4	°C/W	
	Junction to Ambient	$R_{\theta JA}$	50		



### Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

PARAMETER	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNITS	
Static							
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =-250uA -30		-	-	.,	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250uA	-1	-1.8	-2.5	V	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =-10V, I <sub>D</sub> =-20A	-	9.7	12.1	mΩ	
		V <sub>GS</sub> =-4.5V, I <sub>D</sub> =-10A	-	15.3	20		
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =-30V, V <sub>GS</sub> =0V	1	-	-1	uA	
Gate-Source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±25V, V <sub>DS</sub> =0V	1	-	±10		
		V <sub>GS</sub> =±10V, V <sub>DS</sub> =0V	-	-	±1	uA	
Dynamic <sup>(Note 6)</sup>							
Total Gate Charge	$Q_g$	N 04N/ L 00A	-	34	-	nC	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>DS</sub> =-24V, I <sub>D</sub> =-20A,	-	5	-		
Gate-Drain Charge	$Q_{gd}$	V <sub>GS</sub> =-10V	-	9	-		
Input Capacitance	Ciss		-	1610	-		
Output Capacitance	Coss	V <sub>DS</sub> =-25V, V <sub>GS</sub> =0V,	-	273	-	pF	
Reverse Transfer Capacitance	Crss	f=1MHz	-	219	-		
Gate resistance	Rg	f=1MHz	-	8	-	Ω	
Turn-On Delay Time	td <sub>(on)</sub>		-	7	-		
Turn-On Rise Time	tr	V <sub>DS</sub> =-24V, I <sub>D</sub> =-20A,	-	4	-	ns	
Turn-Off Delay Time	td <sub>(off)</sub>	$V_{GS}$ =-10V, $R_{G}$ =3 $\Omega$	-	51	-		
Turn-Off Fall Time	tf	(14010-2)	-	66	-		
Drain-Source Diode							
Diode Forward Current	Is	T 05°0	-	-	-48		
Pulsed Diode Forward Current	I <sub>SM</sub>	T <sub>C</sub> =25°C	-	-	-143	А	
Diode Forward Voltage	V <sub>SD</sub>	Is=-20A, V <sub>G</sub> S=0V	-	-0.85	-1.3	V	
Reverse Recovery Time	Trr	V <sub>GS</sub> =0V, I <sub>S</sub> =-20A	-	16	-	ns	
Reverse Recovery Charge	Qrr	dls/dt=100A/us	-	7	-	nC	

#### NOTES:

- 1. Pulse width<300us, Duty cycle<2%.
- 2. Essentially independent of operating temperature typical characteristics.
- 3. The maximum current rating is package limited.
- 4. R<sub>BJA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. Mounted on a 1 inch<sup>2</sup> with 2oz.square pad of copper.
- 5. The test condition is L=0.5mH,  $I_{AS}$ =-15A,  $V_{DD}$ =-30V,  $V_{GS}$ =-10V, Starting  $T_{J}$ =25°C.
- 6. Guaranteed by design, not subject to production testing.



#### **TYPICAL CHARACTERISTIC CURVES**

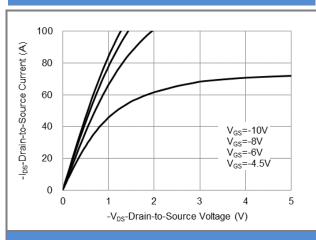


Fig.1 On-Region Characteristics

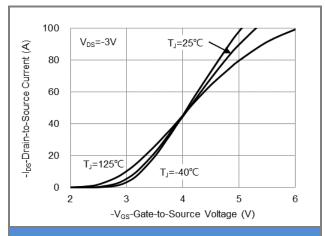


Fig.2 Transfer Characteristics

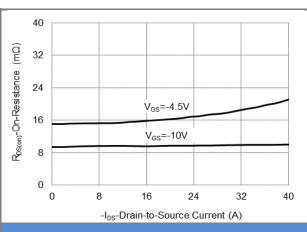


Fig.3 On-Resistance vs. Drain Current

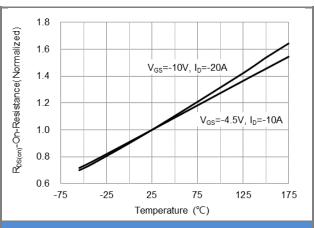


Fig.4 On-Resistance vs. Junction temperature

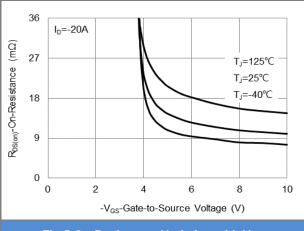
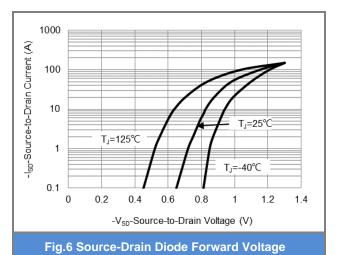


Fig.5 On-Resistance Variation with V<sub>GS</sub>





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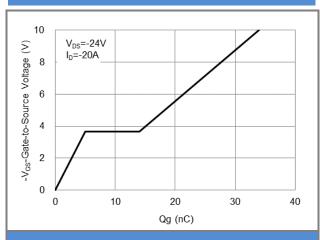


Fig.7 Gate-Charge Characteristics

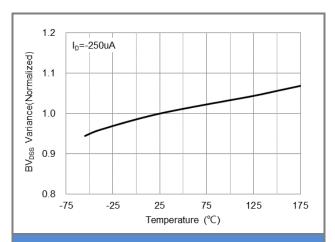


Fig.8 Breakdown Voltage Variation vs. Temperature

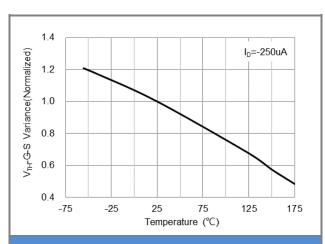


Fig.9 Threshold Voltage Variation with Temperature

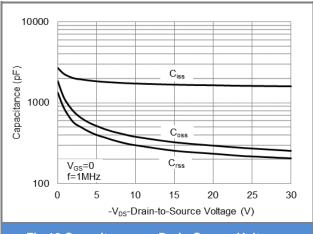


Fig.10 Capacitance vs. Drain-Source Voltage

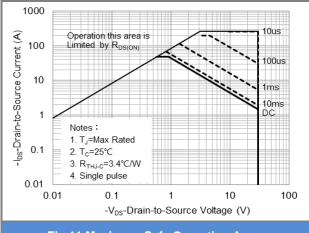


Fig.11 Maximum Safe Operating Area

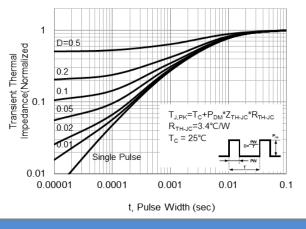


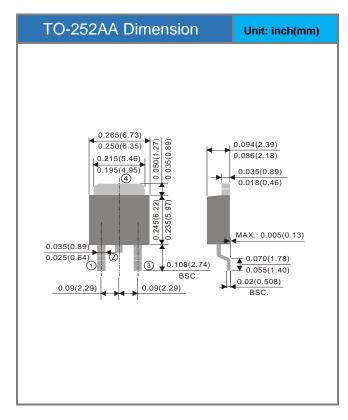
Fig.12 Normalized Transient Thermal Impedance

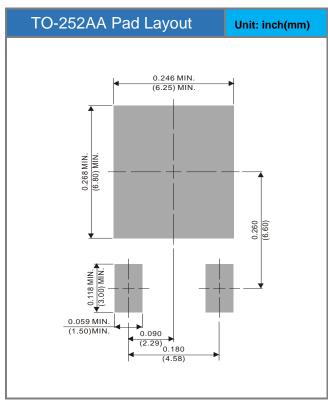


### **Product and Packing Information**

Part No.	Package Type	Packing Type	Marking
PJD55P03E-AU	TO-252AA	3K pcs / 13" reel	D55P03E

### **Packaging Information & Mounting Pad Layout**







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